



## Standalone Linear Li-Ion Battery Charger

### General Description

CYT5026 is a complete constant-current & constant voltage linear charger for single cell Lithium-ion and Lithium-Polymer batteries. Its SOT-23 package and low external component count make CYT5026 ideally suited for portable applications. Furthermore, the CYT5026 is specifically designed to work within USB power specification. At the same time, CYT5026 can also be used in the standalone Lithium-ion and Lithium-Polymer battery charger.

No external sense resistor is needed, and no blocking diode is required due to the internal MOSFET architecture. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be programmed externally with a single resistor. The CYT5026 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

When the input supply (wall adapter or USB supply) is removed, the CYT5026 automatically enters a low current stage, dropping the battery drain current to less than 2 $\mu$ A. The CYT5026 can be put into shutdown mode, reducing the supply current to 25 $\mu$ A.

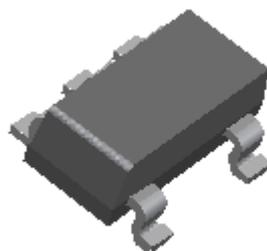
Other features include charge current monitor, undervoltage lockout, automatic recharge and a status pin to indicate charge termination and the presence of an input voltage.

### Features

- Programmable Charge Current Up to 800mA.
- No MOSFET, Sense Resistor or Blocking Diode Required.
- Constant-Current/Constant-Voltage Operation with Thermal Protection to Maximize Charge Rate without Risk of Overheating.
- Charges Single Cell Li-Ion Batteries Directly from USB Port.
- Preset 4.2V Charge Voltage with  $\pm 1\%$  Accuracy.
- 25 $\mu$ A Supply Current in Shutdown.
- 2.9V Trickle Charge Threshold Available Without Trickle Charge.
- Soft-Start Limits Inrush Current.
- Available in 5-Lead SOT-23 Package.

### Applications

- Cellular Telephones, PDA's, MP3 Players.
- Charging Docks and Cradles
- Bluetooth Applications

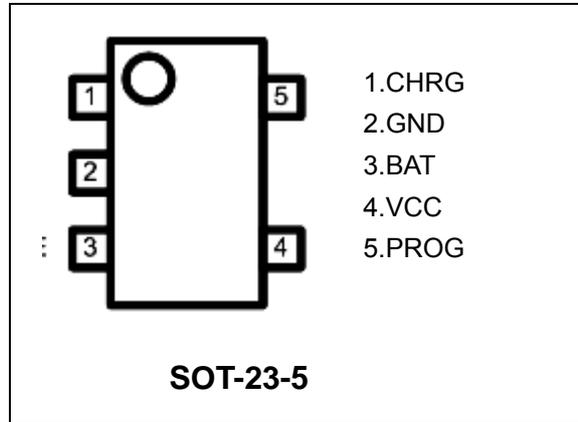


### SOT-23-5 Package

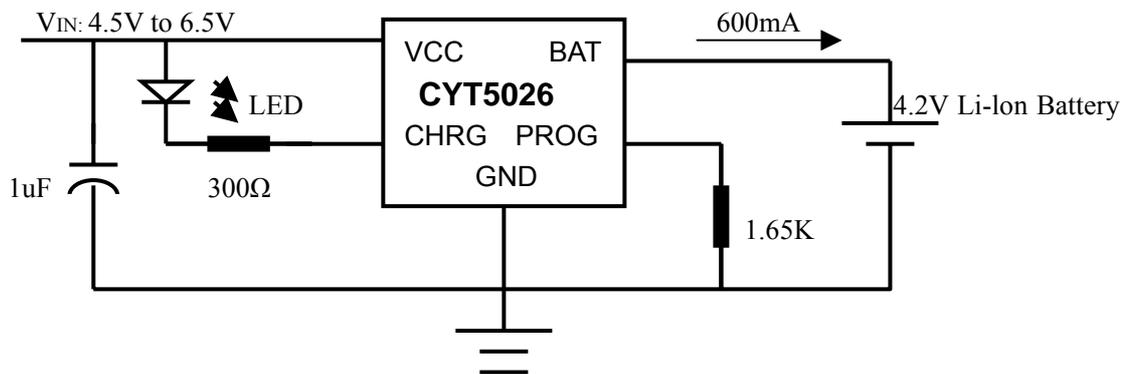
ShenZhen CYT IC Design CO ,Ltd



### Pin Configuration



### Typical Application



600mA Single Cell Li-Ion Charger



## Absolute Maximum Ratings<sup>(1)</sup>

Parameter	Symbol	Value	Units
Input Supply Voltage	V <sub>CC</sub>	10	V
PROG Voltage	V <sub>PROG</sub>	V <sub>CC</sub> +0.3	V
BAT Voltage	V <sub>BAT</sub>	7	V
CHRG Voltage	V <sub>CHRG</sub>	10	V
BAT Short-Circuit Duration		Continuous	
BAT Pin Current	I <sub>BAT</sub>	800	mA
PROG Pin Current	I <sub>PROG</sub>	800	uA
Maximum Junction Temperature	T <sub>J</sub>	125	
Storage Temperature	T <sub>S</sub>	-65 to +125	
Lead Temperature(Soldering, 10 sec)		300	

## Operating Rating<sup>(2)</sup>

Parameter	Symbol	Value	Units
Supply Input Voltage	V <sub>IN</sub>	-0.3 to +10	V
Junction Temperature	T <sub>J</sub>	-40 to +85	

## Electrical Characteristics

V<sub>IN</sub> = 5V; T<sub>J</sub> = 25°C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	Input Supply Voltage		4.25		6	V
I <sub>CC</sub>	Input Supply Current	Charge Mode <sup>(2)</sup> , R <sub>PORG</sub> =10K		190		uA
		Standby Mode(Charge Terminated)		85		uA
		Shutdown Mode(R <sub>PORG</sub> Not Connected, V <sub>CC</sub> < V <sub>BAT</sub> , or V <sub>CC</sub> < V <sub>VUV</sub> )			12	
V <sub>FLOAT</sub>	Regulated Output (Float) Voltage	0 T <sub>J</sub> 85 , I <sub>BAT</sub> =40mA		4.2		V
I <sub>BAT</sub>	BAT Pin Current	R <sub>PORG</sub> =10K , Current Mode		110		mA
		R <sub>PORG</sub> =2K, Current Mode		500		mA
		Standby Mode, V <sub>BAT</sub> =4.2V		4		uA
		Shutdown Mode (R <sub>PORG</sub> Not Connected)		± 1		uA
		Sleep Mode, V <sub>CC</sub> =0V		± 1		uA
I <sub>TRIKL</sub>	Trickle Charge current	V <sub>BAT</sub> < V <sub>TRIKL</sub> , R <sub>PORG</sub> =10K		12		mA
V <sub>TRIKL</sub>	Trickle Charge Threshold Voltage	R <sub>PORG</sub> =10K, V <sub>BAT</sub> Rising		2.9		V
V <sub>VUV</sub>	V <sub>CC</sub> Undervoltage Lockout Threshold	From V <sub>CC</sub> Low to High		3.4		V
V <sub>VUVHYS</sub>	V <sub>CC</sub> Undervoltage Lockout Hysteresis			170		mV



## Electrical Characteristics

$V_{IN} = 5V$ ;  $T_J = 25^{\circ}C$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VMSD	Manual Shutdown Threshold Voltage	PROG Pin Rising		1.25		V
		PROG Pin Rising		1.2		V
VASD	Vcc-VBAT Lockout Threshold Voltage	Vcc from Low to High		100		mV
		Vcc from High to Low		30		mV
ITERM	C/10 Termination Current Threshold	RPROG=10K <sup>(4)</sup>		0.1		mA/mA
		RPROG=2K		0.1		MA/mA
VPROG	PROG Pin Voltage	RPROG=10K , Current Mode		1.03		V
ICHRG	CHRG Pin Weak Pull-Down Current	VCHRG=5V		20		uA
VCHRG	CHRG Pin Output Low Voltage	ICHRG=5mA		0.35		V
VRECHRG	Recharge Battery Threshold Voltage	V FLOAT-VRECHRG		100		mV
TLIM	Thermal Protection Temperature			120		
TSS	Soft-Start Time	IBAT=0 to 1000V/RPROG		100		us
TRECHARGE	Recharge Comparator Filter Time	VBAT High to Low		2		ms
TTERM	Termination Comparator Filter Time	IBAT Falling Below ICHG/10		1000		us
IPROG	PROG Pin Pull-Up Current			1		uA

**Note 1:** Exceeding the absolute maximum rating may damage the device.

**Note 2:** The device is not guaranteed to function outside its operating rating.

**Note 3:** Supply current includes PROG pin current(approximately 100uA) but does not include any current delivered to the battery through the BAT pin (approximately 100mA).

**Note 4:** ITERM is expressed as a fraction of measured full charge current with indicated PROG resistor.

## Application Hints

### Stability Considerations

The constant-voltage mode feedback loop is stable without an output capacitor provided a battery is connected to the charger output. With no battery present,an output capacitor is recommended to reduce ripple voltage.When using high value, low ESR ceramic capacitors, it is recommended to add a 1Ω resistor in series with the capacitor. NO series resistor is needed if tantalum capacitors are used. In constant-current mode, the PROG pin is in the feedback loop, not the battery. The constant-current mode stability is affected by the impedance at the PORG pin, With no additional capacitance on the PROG pin, the charger is stable with program resistor values as high as 20K. However, additional capacitance on this node reduces the maximum allowed program resistor. The pole frequency at the PORG pin should be kept above 100KHz.



## VCC Bypass Capacitor

Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charger input to a live power source. Adding a 1.5Ω resistor in series with a ceramic capacitor will minimize start-up voltage transients.

## Power Dissipation

The conditions that cause the CYT5026 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET-this is calculated to be approximately:

$$PD = (V_{CC} - V_{BAT}) \times I_{BAT}$$

The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

$$T_A = 120^{\circ}\text{C} - P_D \theta_{JA}$$
$$T_A = 120^{\circ}\text{C} - (V_{CC} - V_{BAT}) \cdot I_{BAT} \cdot \theta_{JA}$$

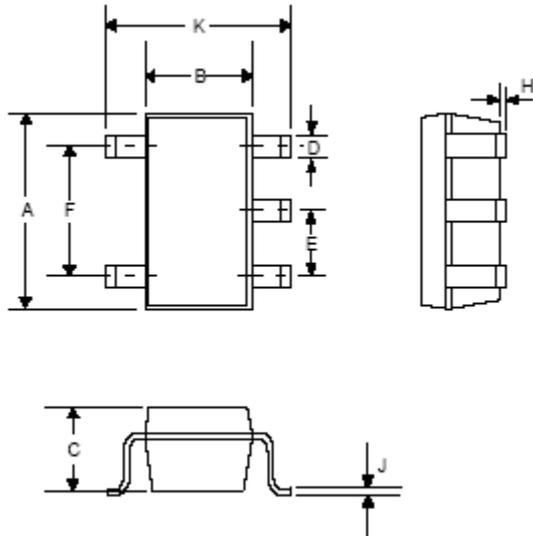
## Thermal Considerations

Because of the small size of the thin SOT-23 package, it is very important to use a good thermal PC board layout to maximize the available charge current. The thermal path for the heat generated by the IC is from the die to the copper lead frame, through the package leads, (especially the ground lead) to the PC board copper. The PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Other heat sources on the board, not related to the charger, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum charge current.



# CYT 5026

## Outline Drawing SOT-23-5



DIMENSIONS				
DIM <sup>N</sup>	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.110	0.120	2.80	3.05
B	0.059	0.070	1.50	1.75
C	0.036	0.051	0.90	1.30
D	0.014	0.020	0.35	0.50
E	-	0.037	-	0.95
F	-	0.075	-	1.90
H	-	0.006	-	0.15
J	0.0035	0.008	0.090	0.20
K	0.102	0.118	2.60	3.00